

DELL Latitude 3540 Intel® Core™ i7 i7-1355U Laptop 39.6 cm (15.6") Full HD 16 GB DDR4-SDRAM 256 GB SSD Wi-Fi 6E (802.11ax) Windows 11 Pro US International Grey

Brand : DELL

Product family: Latitude

Product code: 2YW6X



DELL Latitude 3540. Product type: Laptop, Form factor: Clamshell. Processor family: Intel® Core ™ i7, Processor model: i7-1355U. Display diagonal: 39.6 cm (15.6"), HD type: Full HD, Display resolution: 1920 x 1080 pixels. Internal memory: 16 GB, Internal memory type: DDR4-SDRAM. Total storage capacity: 256 GB, Storage media: SSD. On-board graphics card model: Intel Iris Xe Graphics. Operating system installed: Windows 11 Pro. Product colour: Grey. Weight: 1.81 kg





Design		Network	
Product type * Product colour * Form factor * Display	Laptop Grey Clamshell	Ethernet LAN Ethernet LAN data rates Bluetooth Ports & interfaces	✓ 100,10,1000 Mbit/s ✓
Display diagonal * Display resolution * Touchscreen * HD type Panel type LED backlight Native aspect ratio Anti-glare screen Display brightness Pixel pitch Pixel density RGB colour space Colour gamut Display response rise/fall Maximum refresh rate Contrast ratio (typical)	39.6 cm (15.6") 1920 x 1080 pixels	USB 3.2 Gen 1 (3.1 Gen 1) Type-A ports quantity * USB 3.2 Gen 2 (3.1 Gen 2) Type-C ports quantity Ethernet LAN (RJ-45) ports HDMI ports quantity * HDMI version Combo headphone/mic port Power adapter barrel connector USB Type-C DisplayPort Alternate Mode PowerShare Number of USB ports with PowerShare support Keyboard Pointing device	3 1 1 1 1.4 ✓ 4.5 mm ✓ 1 1 Touchpad
Processor Processor manufacturer * Processor family * Processor generation Processor model * Processor cores Processor threads Processor boost frequency	Intel Intel® Core™ i7 13th gen Intel® Core™ i7 i7-1355U 10 12 5 GHz	Numeric keypad * Keyboard backlit Keyboard language Software Operating system language Trial software Operating system installed *	 US International Multilingual No Microsoft Office License Included 30 day Trial Offer Only Windows 11 Pro

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Network

Wi-Fi data rate (max) Antenna type WLAN controller model WLAN controller manufacturer 2400 Mbit/s 2x2 Intel Wi-Fi 6E AX211 Intel



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